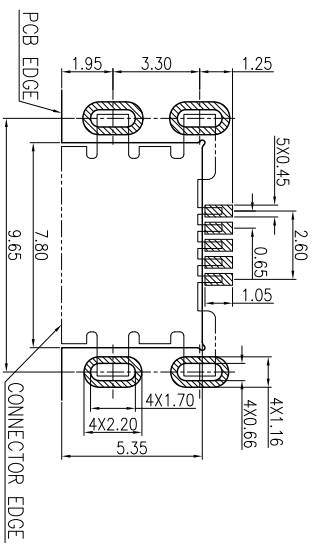
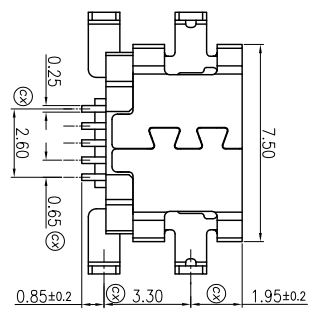
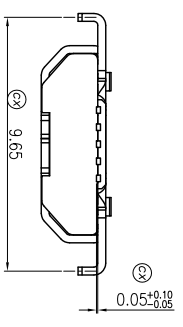
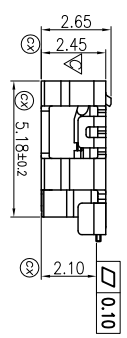
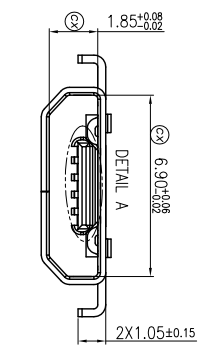
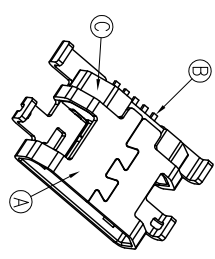
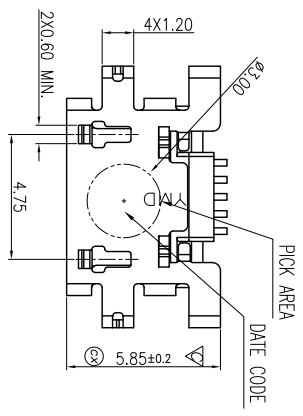


REV.	ECN NO OR DESCRIPTION	REVISED	DATE
A	PRODUCT RELEASE	BILL	16.08.03



- SPECIFICATIONS:**
- 1. ELECTRICAL CHARACTERISTICS:**
- 1-1. RATING CURRENT: 1.8A (PIN1/5), 0.5A (PIN2/3/4)
  - 1-2. CONTACT RESISTANCE: 30mΩ (INITIAL), 40mΩ (AFTER LIFE TEST)
  - 1-3. DIELECTRIC WITHSTANDING VOLTAGE: 100 VAC FOR ONE MINUTE.
  - 1-4. INSULATION RESISTANCE: 1,000MΩ MIN. AT 500 VDC
- 2. MECHANICAL CHARACTERISTICS:**
- 2-1. INSERTION FORCE: 3.6KGF MAX.
  - 2-2. WITHDRAWAL FORCE: 0.8KGF MIN. (REFERENCE)
  - 2-3. LIFE TEST: 10,000 CYCLES.
- 3. ENVIRONMENTAL CHARACTERISTICS:**
- 3-1. SALT MIST TEST CONDITION: PER IEC 68-2-52, SEVERITY(3)
  - 3-2. OPERATING TEMPERATURE: -30~+80°C
  - 3-3. TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
  - 3-4. HALOGEN FREE PRODUCT IDENTIFICATION MARK: ◎
  - 3-5. HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING: ◎
- 4. OTHER GENERAL SPEC. TO REFER "2UB2133-0A2111F SPEC"**
- 5. FOR REFLOW SOLDERING LEAD-FREE PROCESS.**
- 6. ◎ REPRESENT CRITICAL DIMENSIONS.**
- 7. ∇ CPK CONTROLLED DIMENSIONS.**
- 8. PACKAGING: TAPE & REEL**

C	HOUSING	1	PA10 30%GF UL94V-0	BLACK
B	TERMINAL	1	BRASS 0.15T	Au 1μ" MIN. ON CONTACT AREA, Au 1μ" MIN. ON SOLDER TAIL, ALL OVER Ni 80μ" MIN. PLATING
A	SHELL	1	STAINLESS STEEL	MATT TIN 50μ" MIN. PLATING

UNLESS OTHERWISE SPECIFIED TOLERANCES

TITLE	MICRO USB	TYPE	B
DWN	Bill-Zhong	16/08/09	16/08/09
CHKD	Juan-Kuo	16/08/09	16/08/09
APVD	Max-Moi	16/08/09	16/08/09

CUSTOMER COPY

